

FRictionAL BEHAVIOUR OF THIN TIN FILMS WITH A COPPER INTERLAYER

Generally, the purpose of the study is to know the effect of temperature during tin-films deposition on frictional behaviour and lifetime of a tin layer with copper interlayer. In a recent study an experimental approach was performed to investigate the effect of a copper interlayer thickness on frictional behaviour of thin films. In this experiment, copper of 2 μm thickness was deposited between the steel substrate and tin films of 1 μm and 2 μm thicknesses in vacuum environment without and with the heating of the substrate up to 300 °C. The friction tests were performed to determine the friction coefficient and lifetime of lubrication capability.

1. Introduction

Technological use of many tribology products or tribological systems depends on adequate control of friction mechanisms between elements of tribological system consisting of two or more materials. Studies on the surface design, surface engineering, and tribology of coatings and layers have shown that friction and wear of these materials depend significantly on various combinations of materials and environmental conditions.

Micro-tribological phenomena are presently widely investigated. New technologies designed to accomplish the tasks of today and future have also brought about new tribological issues, e.g. efficient drive of machines with micro-tribological joints is limited by power consumption due to friction. The limits of traditional liquid and gaseous lubricants underline the need to use different lubricants for investigation of micro-tribological behaviour of contacting surfaces. In the process of friction and wear thin films, for which the hard substrate keeps up its role, are used in this work. The term thin film refers to a coating of a measurable thickness of up to 2.0 μm . With development of new coating techniques for industrial applications, the significance of thin film lubricants is growing. Such lubrication is commonly used when fluid lubricant could not fulfil its tasks because of high temperature or high vacuum. Other areas of applications which influenced fast innovation of lubricating methods are in the field of aerospace, whole computer media branch, mechatronics and micro machines, where the use of high-tech has become irrevocable. Coatings provide low friction and/or low wear and are often used in a wide range of temperatures, in different environments, including vacuum, usually at low loads and low sliding speeds. The most successful applications enable the reduction of a friction coefficient within a range of two or more order of the magnitude and also lower the wear. [1], [2], [3], [4].

2. Experimental Procedures

2.1 Friction Test Equipment

The equipment used to measure frictional force for a ball slider on a flat surface during experiments under low loads is presented schematically in Fig. 1. The friction test unit was assembled in a vacuum chamber, which was placed on a pneumatic damped table. The vacuum chamber allowed to examine friction behaviour of the tested pairs under different environmental conditions.

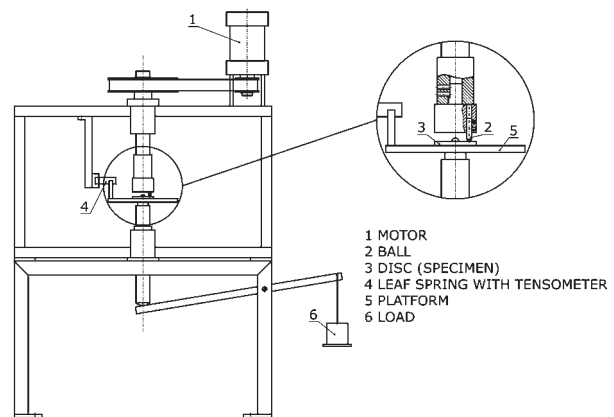


Fig. 1 Friction test apparatus

Friction experiments were carried out in vacuum of 10^{-5} Pa order. The stainless steel ball of a 3 mm diameter was fixed on the tip of the holder. The holder was arranged coaxially in a diameter

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of 20 mm and the ball rotated on a coated disk specimen with a controlled sliding speed of 8 mm/sec. The load of 100 g applied to the ball resulted in normal force of 1N. The resulted friction forces were measured with a strain gauge placed on a leaf spring. The endurance life friction experiment continued until the tin film broke down. The criterion defining the break down of the film was marked by a sudden or substantial increase in the calculated and measured friction coefficient.

2.2 Temperature Measurement of Substrate

In recent experiments the temperature was measured with a thermocouple attached close to the substrate. There was a hypothesis that the real temperature of the substrate depending on the place of measurement is different from the one showed by the thermocouple. To verify this hypothesis a preliminary testing was undergone. The heater attached to the top of the deposition chamber (Fig. 2) was used for heating. The heater crystal was situated direct above the substrate. The temperature of specimens was measured according to the following procedure:

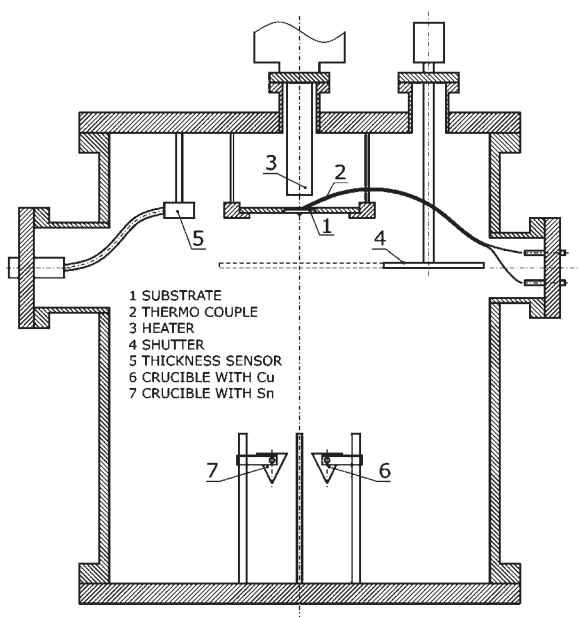


Fig. 2 Film deposition chamber

For the first case

The temperature of the heated specimen side was measured. The specimen substrate was heated continuously up to 300 °C and this temperature remained unchanged for the next 3 hours. Figure 3 shows that the temperature difference measured at two points, i. e. in the margin and in the centre of the substrate, is not significant. So, it can be assumed that there is no remarkable effect on the measurement accuracy of the thin film deposition if the thermo-

couple is placed in the margin or in the centre of the specimen substrate.

For the second case

The temperature was measured on both sides of the specimen. Two methods for the heating of the specimens were applied.

For the first method, the so-called programmed consistent heating method was chosen. The upper side of the substrate was heated to 100 °C and remained at this temperature for 30 minutes, then the temperature was increased to 200 °C and, again, remained unchanged for the next 30 minutes. Later the temperature was increased to 300 °C and was kept unchanged for 30 minutes (Figure 4).

For the second method, the upper side of the substrate was heated up to 300 °C and kept unchanged for 3 hours (Figure 5). The same procedure was repeated for the temperature of 400 °C (Figure 6).

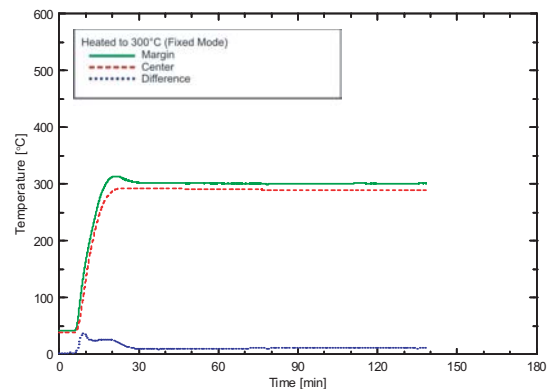


Fig. 3. Temperature in the margin and in the centre of specimen

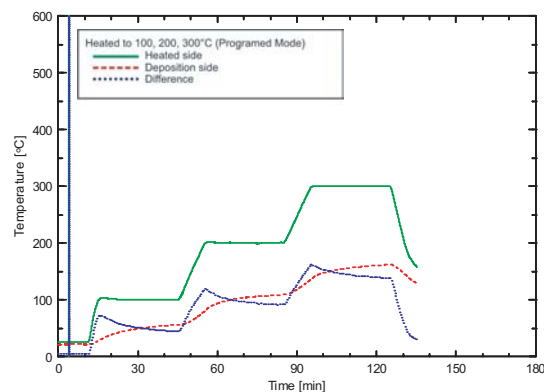


Fig. 4. Programmed consistent heating

For both methods the temperatures on the heated and deposition sides were measured. The results show that the temperature

on the deposition side is nearly by 50% lower when compared to the temperature on the heated side. Accordingly, it can be assumed that, in the case of deposition with heating up to 300 °C measured on the heated side, the real temperature of the substrate on the deposition side will reach the temperature of only 180 °C.

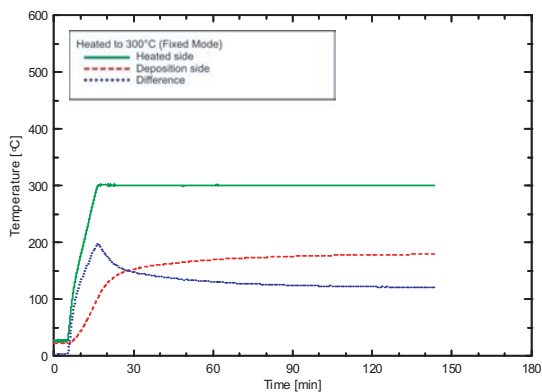


Fig. 5. Heating to 300 °C

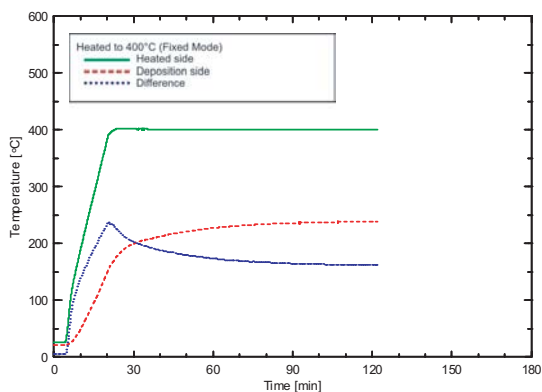


Fig. 6. Heating to 400 °C

2.3 Deposition of Cu and Sn Films for Friction Tests

Before starting the deposition of copper and tin layers for friction tests, the device for thickness monitoring was calibrated. This means that the copper layer on the silicon substrate as well as the tin layer on the silicon substrate were deposited. In cooperation with Kawamura Research Laboratories the Cu and Sn layer thickness was measured with a VK-8500 laser microscope. When the measurement was over the calibration/tooling numbers for Cu and Sn were calculated and set as the thickness reference into the monitor device.

For experiments the thin Sn and Cu films were deposited on a prepared stainless steel substrate by a vacuum deposition method in the evaporating apparatus where the values for vacuum reached 10^{-5} Pa. The deposited metals, i.e. Sn and Cu were evaporated from separate crucibles (Figure 2). The copper layer of 2.0 μm thickness used as an inter-metallic layer was deposited as the first

layer to the substrate. After a cooling period of 4 hours the deposition process of the tin layer followed.

There were two different thicknesses of the Sn layer applied: one being 1.0 μm thick and another being 2.0 μm thick. For both film thicknesses the deposition started at a normal room temperature and such specimens are referred to as no-heated. For the specimens referred to as heated, the substrates were heated up to 300 °C, measured on the heated side before the deposition started.

3. Results and discussion

The experimental results aimed at determination of lifetime and friction behaviour of the tested pairs in dependence on the film thickness and based on heated and no-heated substrates before the thin layer deposition are shown in Figs. 7 - 10.

Figure 7 shows two typical results of the test performed with the heated specimen (tin film thickness of 1 μm). The value of the coefficient of friction developed in a very different way. It can be easily seen that for the same experimental conditions the coefficient of friction reached the values within the range of $\mu = 0.2$ to 0.7. Lifetime of the friction pair is also remarkably different and varies from several minutes to tens of hours.

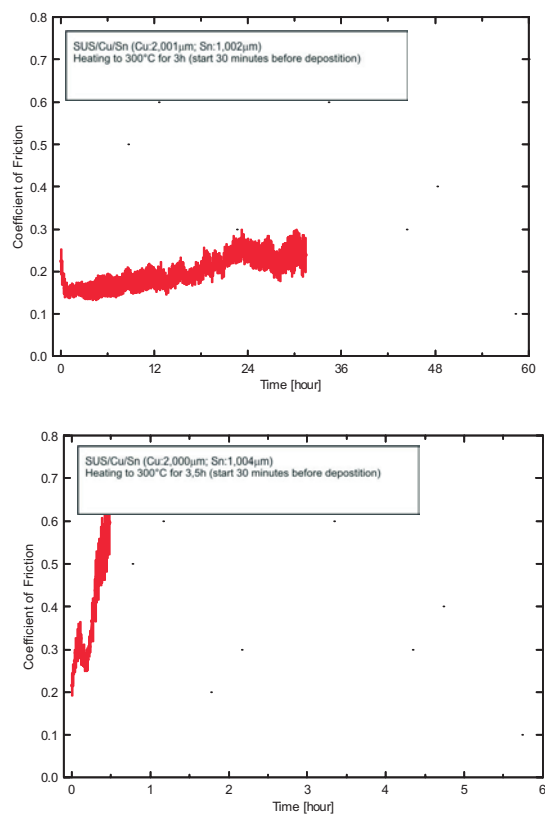


Fig. 7. Friction tests of heated specimens: Cu being 2.0 μm and Sn being 1.0 μm thick

The friction behaviour of the tin film 2 μm thick is plotted in Fig. 8. After the initial phase the friction coefficient slightly decreased to the values $\mu = 0.12 - 0.15$ and remained nearly constant for the whole testing time.

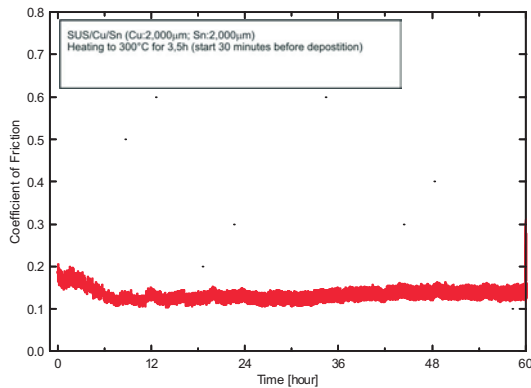


Fig. 8. Friction tests of heated specimens: Cu being 2.0 μm and Sn 2.0 μm thick

The experimental results for friction pairs composed of no-heated specimens of Cu 2.0 μm thick and Sn 1.0 μm or 2.0 μm thick are shown in Figures 9 and 10 respectively. For all the tested pairs there is a remarkable difference in lifetime. The same conclusion is valid for the level of friction $\mu = 0.1$ to 0.3, which was almost unstable with an increasing tendency within 12 hours of testing.

An interesting similarity with Fig. 7 can be seen in Fig. 10, which shows two typical results of the test performed with the no-heated specimen. The values of the friction coefficient do not vary significantly but it can be easily seen that for the same experimental conditions the lifetime of the friction pair is remarkably different.

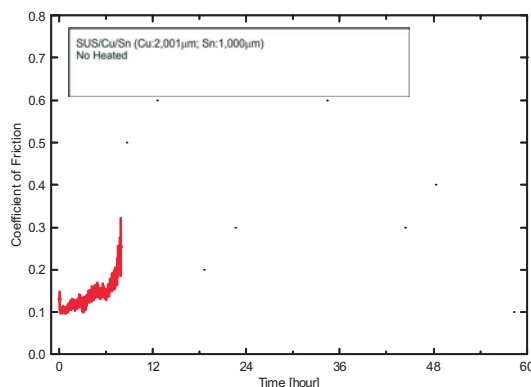


Fig. 9. Friction tests of no-heated specimens: Cu being 2.0 μm and Sn being 1.0 μm thick

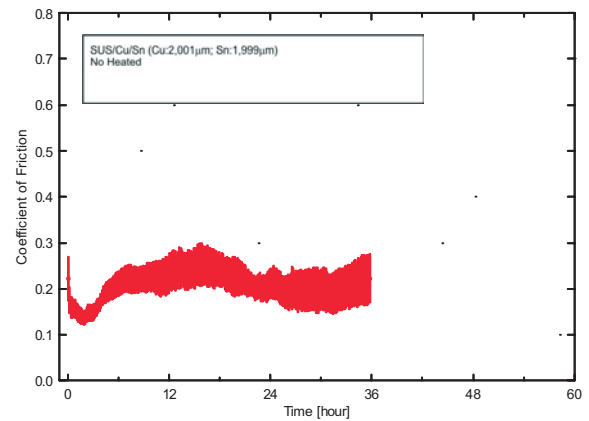
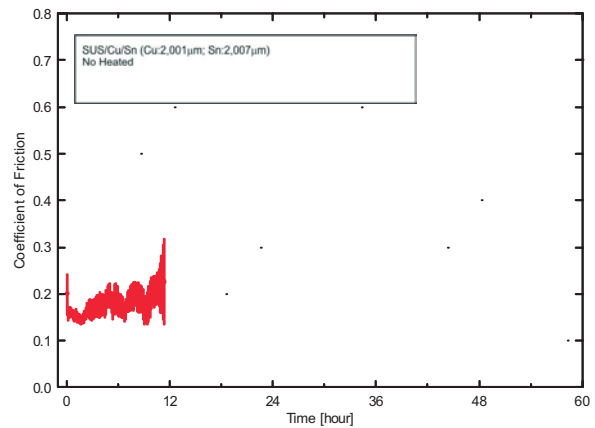


Fig. 10. Friction tests of no-heated specimens: Cu being 2.0 μm and Sn being 2.0 μm thick

4. Conclusions

Frictional properties and their influence on lifetime of friction pairs with thin tin films deposited on a copper interlayer with a constant thickness of 2.0 μm on a stainless steel substrate were investigated. For frictional properties the thinner tin films generally showed higher values for the heated specimens. For the no-heated specimens the values oscillated around $\mu = 0.2$.

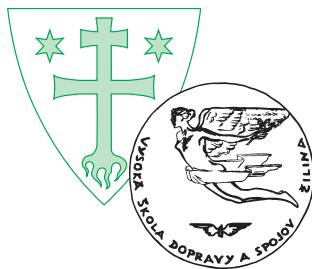
However, lifetime grows with an increasing thickness of a Sn layer. Considering also the heating of the substrate, in the case of heated specimens the lifetime is longer than for the no-heated ones.

The difference in lifetime for both types of specimens, i.e. with the heated and no-heated substrate as referred to in Figs. 7 - 10 will need more experimental investigation. Intermetallic compounds between copper and tin (mostly there are two kinds of intermetallic compounds, Cu_6Sn_5 and Cu_3Sn) emerging during the deposition phase could be responsible for this phenomenon.

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